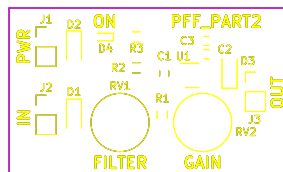


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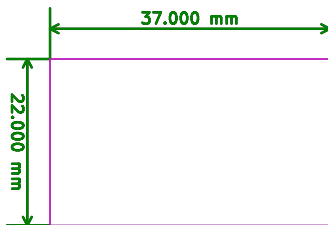


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- 1. General: Acceptability criteria per IPC-6012 Class 2.
- 2. Material: 370HR Laminates and prepregs or IPC-4101/101 equivalent. RoHS compliant no lead PCB. Laminate must conform to UL 94V-0.
- 3. Dimensions: Overall dimensions must be +/- 0.1mm.
- 4. Thickness: 62mil +/- 10% (Finished).
- 5. Plating: Foil 0.5oz and plate up to 1.0oz copper on outer layers. Plated holes shall have minimum average copper thickness of 0.25mm with an absolute minimum thickness of 0.2mm.
- 6. Finish: ENIG per IPC-4552.
- 7. Annular Ring: Breakthrough is not permitted.
- 8. Solder Mask: SMOBC liquid photo imageable soldermask, green in color.
- 9. Silkscreen: White, non-conductive ink.
- 10. PCB: Nominal conductor width/space (12mil/8mil)
- 11. Drill Tolerance: Must be +/- 0.08mm.
- 12. Solderability: Shall be in accordance with IPC.

Signal Amplifier, Adjustable Gain and Filter By Benjamin Corman		
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Size: A4	Date: 2017-07-13	Rev: A
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